

## Features

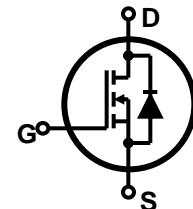
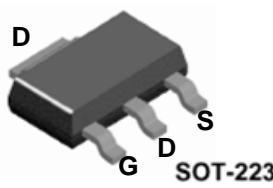
- Low gate charge
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant
- Halogen free package
- JEDEC Qualification

$V_{DSS} = 330V @ T_{jmax}$

$I_D = 3A$

$R_{DS(on)} = 2.15 \Omega(\text{max}) @ V_{GS}= 10 V$

$R_{DS(on)} = 1.73 \Omega(\text{typ}) @ V_{GS}= 10 V$



| Device   | Package | Marking  |
|----------|---------|----------|
| TMT3N30G | SOT223  | TMT3N30G |

## Absolute Maximum Ratings

| Parameter  | Symbol         | TMT3N30G | Unit                |
|--|----------------|----------|---------------------|
| Drain-Source Voltage   | $V_{DS}$       | 300      | V                   |
| Gate-Source Voltage  | $V_{GS}$       | $\pm 30$ | V                   |
| Continuous Drain Current<br><br>$T_C = 25 \text{ }^\circ\text{C}$                | $I_D$          | 3.0*     | A                   |
|  |                | 1.7*     | A                   |
| Pulsed Drain Current (Note 1)  | $I_{DM}$       | 12*      | A                   |
| Single Pulse Avalanche Energy (Note 2)   | $E_{AS}$       | 50       | mJ                  |
| Repetitive Avalanche Current (Note 1)  | $I_{AR}$       | 3        | A                   |
| Repetitive Avalanche Energy (Note 1)   | $E_{AR}$       | 0.2      | mJ                  |
| Power Dissipation<br><br>$T_C = 25 \text{ }^\circ\text{C}$                       | $P_D$          | 2        | W                   |
|  |                | 0.02     | W/ $^\circ\text{C}$ |
| Peak Diode Recovery dv/dt (Note 3)   | dv/dt          | 4.5      | V/ns                |
| Operating Junction and Storage Temperature Range                                 | $T_J, T_{STG}$ | -55~150  | $^\circ\text{C}$    |
| Maximum lead temperature for soldering purposes,<br>1/8" from case for 5 seconds | $T_L$          | 300      | $^\circ\text{C}$    |

\* Limited only by maximum junction temperature

## Thermal Characteristics

| Parameter                                       | Symbol          | TMT3N30G | Unit               |
|---|-----------------|----------|--------------------|
| Maximum Thermal resistance, Junction-to-Ambient | $R_{\theta JA}$ | 62.5     | $^\circ\text{C/W}$ |

**Electrical Characteristics :  $T_c=25^\circ\text{C}$ , unless otherwise noted**

| Parameter   | Symbol                      | Test condition  | Min | Typ  | Max  | Units         |
|---|-----------------------------|---|-----|------|------|---------------|
| <b>OFF</b>  |                             |   |     |      |      |               |
| Drain-Source Breakdown Voltage                        | $\text{BV}_{\text{DSS}}$    | $V_{\text{GS}} = 0 \text{ V}, I_{\text{D}} = 250 \mu\text{A}$   | 300 | --   | --   | V             |
| Zero Gate Voltage Drain Current                       | $I_{\text{DS}}^{\text{SS}}$ | $V_{\text{DS}} = 300 \text{ V}, V_{\text{GS}} = 0 \text{ V}$  | --  | --   | 1    | $\mu\text{A}$ |
|   |                             | $V_{\text{DS}} = 240 \text{ V}, T_c = 125^\circ\text{C}$  | --  | --   | 10   | $\mu\text{A}$ |
| Forward Gate-Source Leakage Current                   | $I_{\text{GSSF}}$           | $V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$   | --  | --   | 100  | nA            |
| Reverse Gate-Source Leakage Current                   | $I_{\text{GSSR}}$           | $V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$  | --  | --   | -100 | nA            |
| <b>ON</b>   |                             |   |     |      |      |               |
| Gate Threshold Voltage                                | $V_{\text{GS(th)}}$         | $V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \mu\text{A}$   | 2   | --   | 4    | V             |
| Drain-Source On-Resistance                            | $R_{\text{DS(on)}}$         | $V_{\text{GS}} = 10 \text{ V}, I_{\text{D}} = 1.5 \text{ A}$  | --  | 1.73 | 2.15 | $\Omega$      |
| Forward Transconductance <sup>(Note 4)</sup>          | $g_{\text{FS}}$             | $V_{\text{DS}} = 30 \text{ V}, I_{\text{D}} = 1.5 \text{ A}$  | --  | 9    | --   | S             |
| <b>DYNAMIC</b>  |                             |   |     |      |      |               |
| Input Capacitance                                     | $C_{\text{iss}}$            | $V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$                              | --  | 220  | --   | pF            |
| Output Capacitance                                    | $C_{\text{oss}}$            |   | --  | 35   | --   | pF            |
| Reverse Transfer Capacitance                          | $C_{\text{rss}}$            |   | --  | 2.2  | --   | pF            |
| <b>SWITCHING</b>                                      |                             |   |     |      |      |               |
| Turn-On Delay Time <sup>(Note 4,5)</sup>              | $t_{\text{d(on)}}$          | $V_{\text{DD}} = 150 \text{ V}, I_{\text{D}} = 3 \text{ A}, R_{\text{G}} = 25 \Omega$                         | --  | 38   | --   | ns            |
| Turn-On Rise Time <sup>(Note 4,5)</sup>               | $t_r$                       |   | --  | 30   | --   | ns            |
| Turn-Off Delay Time <sup>(Note 4,5)</sup>             | $t_{\text{d(off)}}$         |   | --  | 42   | --   | ns            |
| Turn-Off Fall Time <sup>(Note 4,5)</sup>              | $t_f$                       |   | --  | 24   | --   | ns            |
| Total Gate Charge <sup>(Note 4,5)</sup>               | $Q_g$                       | $V_{\text{DS}} = 240 \text{ V}, I_{\text{D}} = 3 \text{ A}, V_{\text{GS}} = 10 \text{ V}$                     | --  | 4.4  | --   | nC            |
| Gate-Source Charge <sup>(Note 4,5)</sup>              | $Q_{\text{gs}}$             |   | --  | 1.4  | --   | nC            |
| Gate-Drain Charge <sup>(Note 4,5)</sup>               | $Q_{\text{gd}}$             |   | --  | 1.3  | --   | nC            |
| <b>SOURCE DRAIN DIODE</b>                             |                             |   |     |      |      |               |
| Maximum Continuous Drain-Source Diode Forward Current | $I_s$                       | ---   | --  | --   | 3    | A             |
| Maximum Pulsed Drain-Source Diode Forward Current     | $I_{\text{SM}}$             | ---   | --  | --   | 12   | A             |
| Drain-Source Diode Forward Voltage                    | $V_{\text{SD}}$             | $V_{\text{GS}} = 0 \text{ V}, I_{\text{S}} = 3 \text{ A}$   | --  | --   | 1.5  | V             |
| Reverse Recovery Time <sup>(Note 4)</sup>             | $t_{\text{rr}}$             | $V_{\text{GS}} = 0 \text{ V}, I_{\text{S}} = 3 \text{ A}$<br>$dI_{\text{F}} / dt = 100 \text{ A}/\mu\text{s}$ | --  | 149  | --   | ns            |
| Reverse Recovery Charge <sup>(Note 4)</sup>           | $Q_{\text{rr}}$             |   | --  | 0.49 | --   | $\mu\text{C}$ |

**Note :**

1. Repeated rating : Pulse width limited by safe operating area
2.  $L=9.3\text{mH}, I_{\text{AS}}=3\text{A}, V_{\text{DD}}=50\text{V}, R_{\text{G}}=25\Omega$ , Starting  $T_j=25^\circ\text{C}$
3.  $I_{\text{SD}} \leq 3\text{A}, di/dt \leq 200\text{A}/\mu\text{s}, V_{\text{DD}} \leq BV_{\text{DS}}$ , Starting  $T_j=25^\circ\text{C}$
4. Pulse width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$
5. Essentially Independent of Operating Temperature Typical Characteristics

